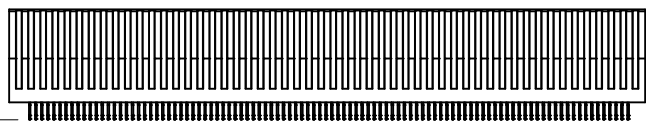


PART NUMBER	VERSION	BAY 1/BAY 2	TOTAL CIRCUITS	DIM A	SALES DRAWING (SEE NOTE 8)
170673-2278	2 BAY	146/132	278	118.63	SD-170673-2278
170673-1200	1 BAY	200	200	84.20	SD-170673-1200
170673-2108	2 BAY	86/22	108	50.63	SD-170673-2108
170673-2080	2 BAY	52/28	80	39.43	SD-170673-2080
170673-1046	1 BAY	46	46	22.60	SD-170673-1046

2 BAY EDGELINE



1 BAY EDGELINE



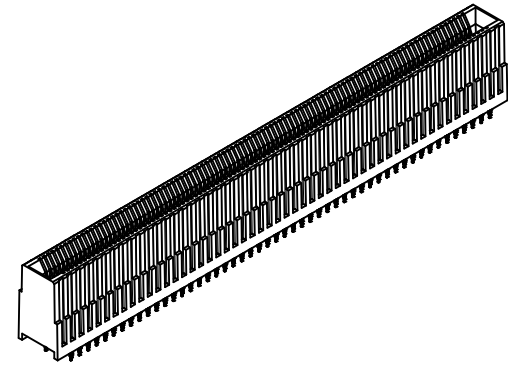
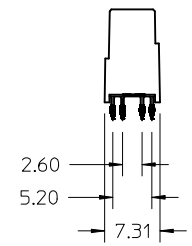
LAST CIRCUIT



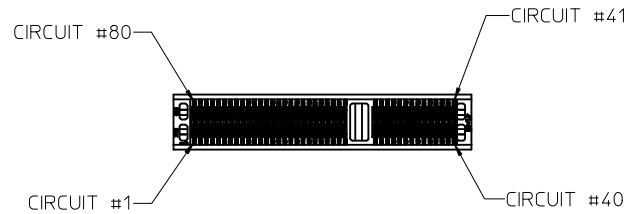
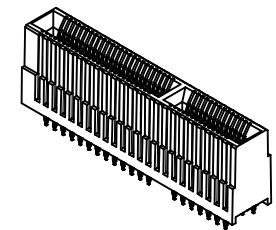
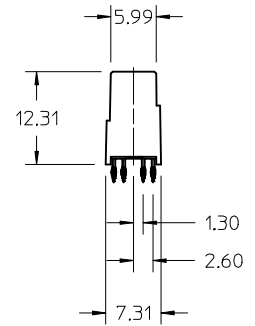
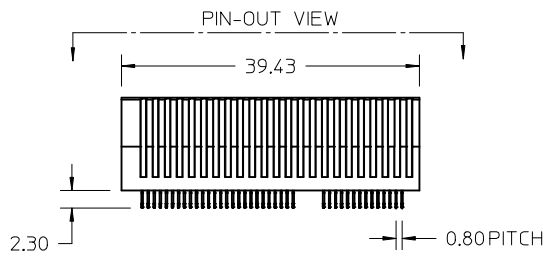
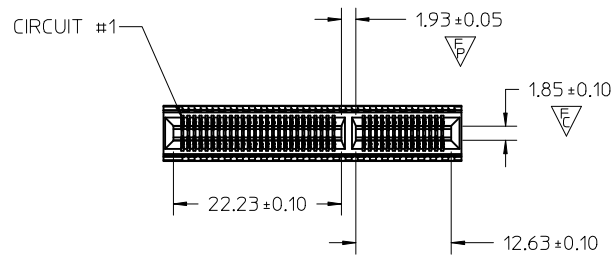
FIRST CIRCUIT

NOTES:

- MATERIAL:
HOUSING - GLASS FILLED THERMOPLASTIC, 94-V0, BLACK
TERMINALS - COPPER ALLOY
- FINISH:
CONTACT AREA: HARD GOLD -0.76μm MIN OVER 3.80μ NICKEL
COMPLIANT AREA: TIN - 0.76/1.52μm OVER NICKEL
- REFER TO PS-75594-999 PRODUCT SPECIFICATION FOR ALL ELECTRICAL, MECHANICAL AND ENVIROMENTAL SPECIFICATIONS.
- PROCESSING: PRESSFIT TO PC BOARD.
- MATING PC BOARD THICKNESS = 1.60±0.16MM OVER CONTACT PADS.
- PRODUCT IS ELV AND RoHS COMPLIANT. LEVEL OF COMPLIANCE: 6/6
ALL BANNED SUBSTANCES ARE REMOVED:
Pb (LEAD)
HEXAVALENT CHROMIUM (CrVI)
CADMIUM
MERCURY
POLYBRMINATED BIPHENYL (PBB)
POLYBROMINATED DIPHENYL ETHER (PBDE)
- THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPEC PS-45499-002
- FOR EDGECARD AND MOUNTING PCB LAYOUT DETAIL SEE CORRESPONDING SALES DRAWING.



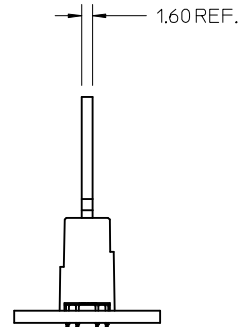
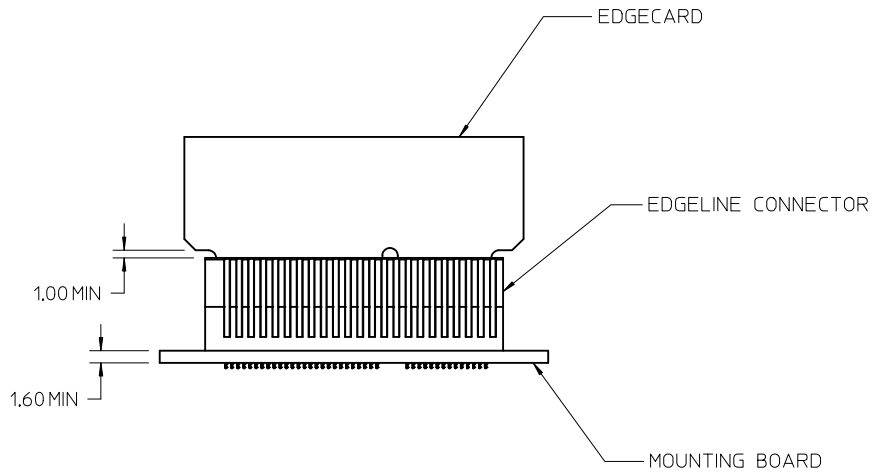
RELEASED REV A EC NO: UCP2011-2702 DRWNG: DROSCA 2011/03/07 CHKD: JCOMERCI 2011/03/28 APPR: JCOMERCI 2011/03/28	DESCRIPTION REV: A	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION	
		▽ = 0	mm INCH	MM ONLY	2:1	METRIC		
		▽ = 0	4 PLACES ± --- ± ---	DRAWN BY DATE	EDGELINE 12.5GB 0.062"PCB 0.8MM PITCH			
		▽ = 0	3 PLACES ± --- ± ---	CHECKED BY DATE				
		ANGULAR ±1/2°	2 PLACES ± --- ± ---	JCOMERCI 2010/06/22	MOLEX INCORPORATED			
			1 PLACE ± --- ± ---	APPROVED BY DATE				DOCUMENT NO. SD-170673-0001
				JCOMERCI 2010/10/25	SHEET NO. 1 OF 1			
				MATERIAL NO.			THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION	
				SIZE	SEE TABLE			



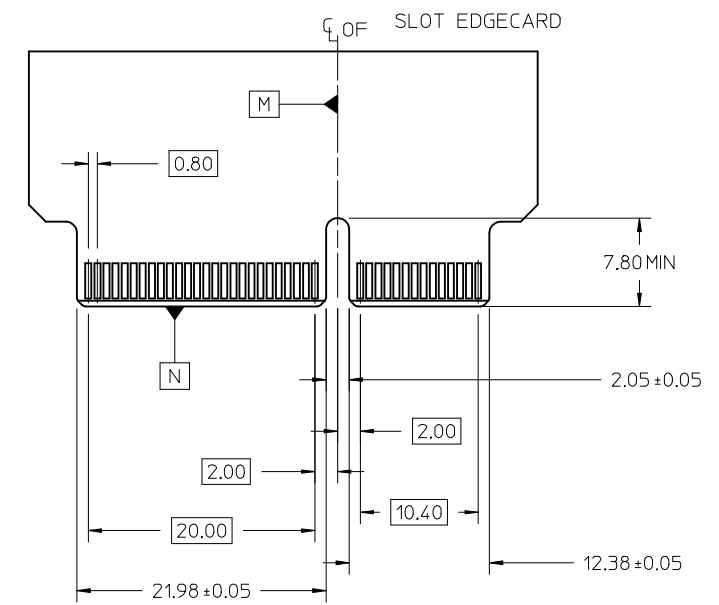
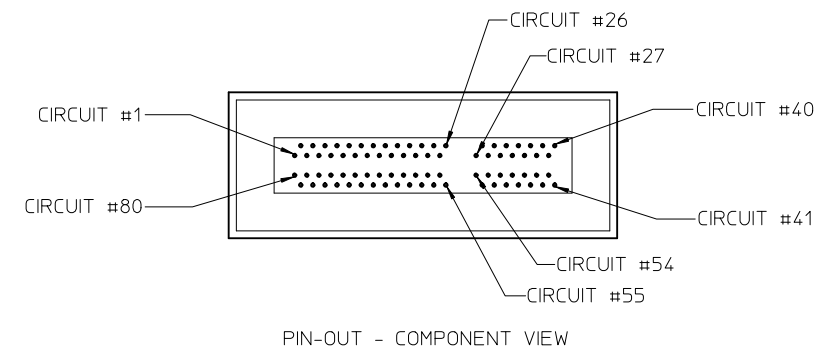
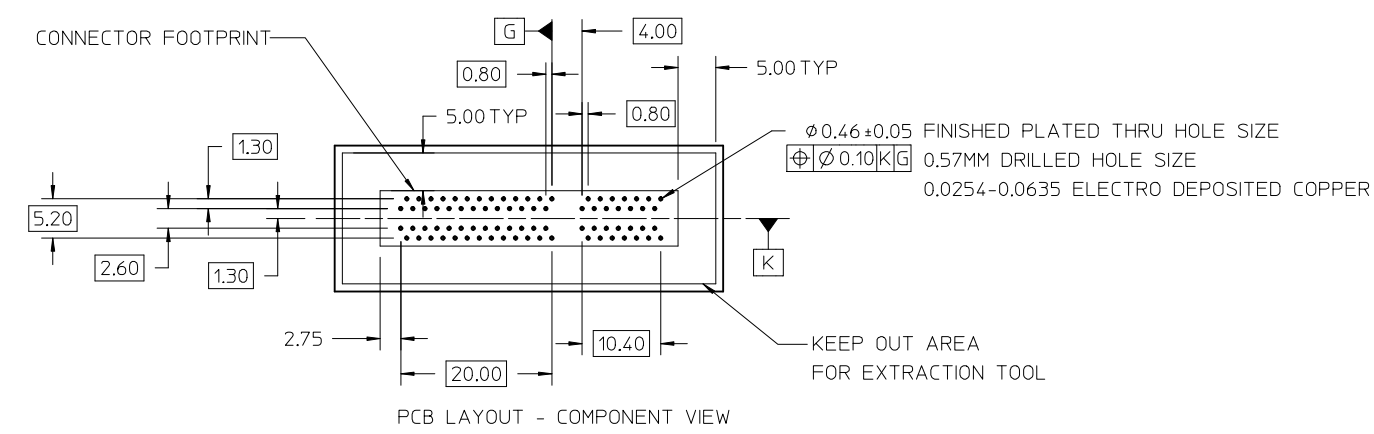
- NOTES:
- MATERIAL:
HOUSING - GLASS FILLED THERMOPLASTIC, 94-V0, BLACK
TERMINALS - COPPER ALLOY
 - FINISH:
CONTACT AREA: HARD GOLD -0.76μm MIN OVER 3.80μ NICKEL
COMPLIANT AREA: TIN - 0.76/1.52μm OVER NICKEL
 - REFER TO PS-75594-999 PRODUCT SPECIFICATION FOR ALL ELECTRICAL, MECHANICAL AND ENVIRONMENTAL SPECIFICATIONS.
 - REFER TO PK-76693-900 FOR ALL PACKAGING SPECIFICATIONS.
 - PROCESSING: PRESSFIT TO PC BOARD.
 - MATING PC BOARD THICKNESS = 1.60±0.16MM OVER CONTACT PADS.
 - THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPEC PS-45499-002

CORRECT EDGE CARD WIDTH TOLERANCE TEC NO: UCP2016-4620 DRAWINGS: 2016/06/02 CHKD: APPR:DMCGOWAN 2016/06/13	QUALITY SYMBOLS ▽=0 ▽=1 ▽=1	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 2:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		mm	INCH	DRAWN BY DROSCA	DATE 2011/03/18	TITLE EDGELINE 12.5GB 80CKTS 0.062*PCB 0.8MM PITCH				
D	REV	4 PLACES	± ---	± ---	CHECKED BY JCOMERC I	DATE 2011/03/28	DOCUMENT NO. SD-170673-2080			
		3 PLACES	± ---	± ---	APPROVED BY JCOMERC I	DATE 2011/03/28				
		2 PLACES	± 0.15	± ---			SHEET NO. 1 OF 4			
		1 PLACE	± 0.25	± ---						
		0 PLACE	±	±			THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			
		ANGULAR ± 2 °		SIZE C						

EDGELINE CONNECTOR BOARD MOUNTING

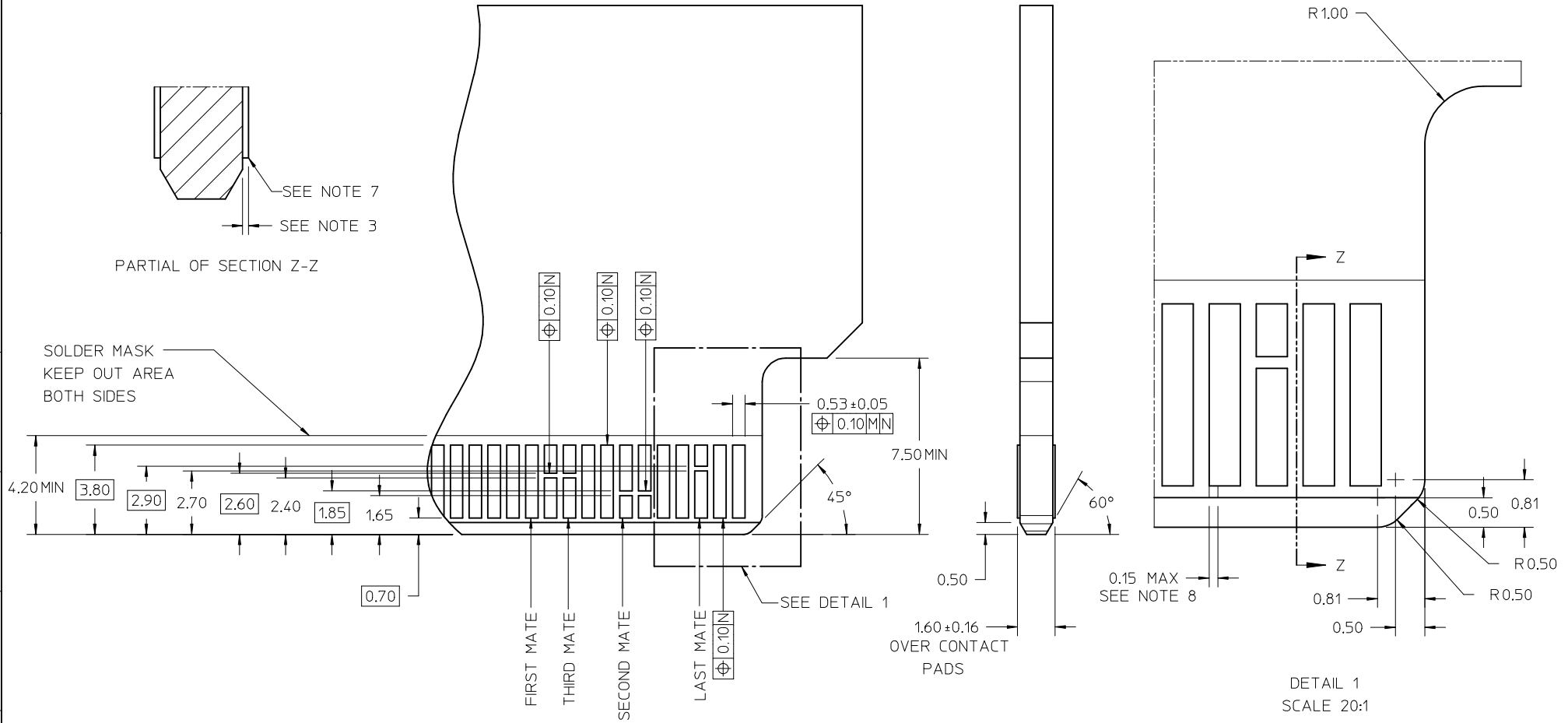


SEE SHEET 1 EC NO: UCP2016-4620 DRAWINGS 2016/06/02 CHKD: [blank] APPR:DMCGOWAN 2016/06/13	DESCRIPTION REV: [blank]	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE MM ONLY	SCALE 2:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
		▽=0	mm INCH	DRAWN BY DATE DROSCA 2011/03/18	TITLE EDGELINE 12.5GB 80CKTS 0.062*PCB 0.8MM PITCH		
		▽=0	4 PLACES ± --- ± ---	CHECKED BY DATE JCOMERC I 2011/03/28	molex		
		▽=0	3 PLACES ± --- ± ---	APPROVED BY DATE JCOMERC I 2011/03/28			
		ANGULAR ± 2 °	MATERIAL NO.	DOCUMENT NO.	SHEET NO.		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	SEE SHEET 1	SD-170673-2080	2 OF 4		
			SIZE C	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			



SEE SHEET 1 EC NO: UCP2016-4620 DRAWINGS 2016/06/02 CHKD: JCOMERC I APPR: DMCGOWAN 2016/06/13	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION
	▽=0	mm INCH	MM ONLY	2:1	METRIC	
	▽=0	4 PLACES ± --- ± ---	DRAWN BY DATE	TITLE		
	▽=0	3 PLACES ± --- ± ---	DROSCA 2011/03/18	EDGELINE 12.5GB 80CKTS 0.062"PCB 0.8MM PITCH		
		2 PLACES ± 0.15 ± ---	CHECKED BY DATE	molex DOCUMENT NO. SD-170673-2080 SHEET NO. 3 OF 4		
		1 PLACE ± 0.25 ± ---	JCOMERC I 2011/03/28			
		0 PLACE ± ±	APPROVED BY DATE	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		
			JCOMERC I 2011/03/28			
		ANGULAR ± 2 °	MATERIAL NO.			
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	SEE SHEET 1			

MODULE EDGE CARD CONTACT DETAIL



MATING PCB NOTES:

- CONNECTOR LAND CONDITIONS SHALL MEET THE MOST CURRENT REVISION OF PCB SPECIFICATION IPC-6012C-2010 SECTION 3.5.4.4.
- DIMENSIONS APPLY TO LANDS ON BOTH SIDES OF THE BOARD.
- THE THICKNESS OF THE OUTER METAL LAYERS, INCLUDING FOIL, COPPER PLATING, AND THE PROTECTIVE SURFACE FINISH, SHALL BE 0.066mm MAX.
- CHAMFER ROUGHNESS NOT TO EXCEED 3.17 MICROMETERS.
- CHAMFER PROCESS SHALL NOT DAMAGE THE GOLD EDGE LANDS.
- EDGECARD CHAMFER NOT TO GO THRU GOLD LANDS.
- 0.03mm MAX PLATING OVERHANG ON ALL GOLD LAND EDGES.
- MOLEX RECOMMENDS NO TIE-BARS ON THE LEADING EDGE OF THE GOLD LAND. IF TIE-BARS ARE USED, THEY SHALL BE PLACED TO ONE SIDE OF THE GOLD LAND. APPLIES TO ALL GOLD LANDS.

SEE SHEET 1 EC NO: UCP2016-4620 DRWNGES 2016/06/02 CHKD: APPR:DMCGOWAN 2016/06/13	QUALITY SYMBOLS ▽=0 ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 8:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		mm	INCH	DRAWN BY	DATE	TITLE		EDGELINE 12.5GB 80CKTS 0.062"PCB 0.8MM PITCH		
D REV	DESCRIPTION	4 PLACES	± ---	± ---	DROSCA	2011/03/18	DOCUMENT NO. SD-170673-2080			
		3 PLACES	± ---	± ---	CHECKED BY	DATE				
		2 PLACES	± 0.15	± ---	JCOMERC I	2011/03/28				
		1 PLACE	± 0.25	± ---	APPROVED BY	DATE				
0 PLACE	±	±	JCOMERC I	2011/03/28	MATERIAL NO. SEE SHEET 1		SHEET NO. 4 OF 4			
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		ANGULAR ± 2 °		SIZE C		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				